

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Sung Gun LEE</td> <td>04/09/2012</td> </tr> <tr> <td>Yong Tak Hyun</td> <td>04/09/2012</td> </tr> </tbody> </table>		Name	Execution Date	Sung Gun LEE	04/09/2012	Yong Tak Hyun	04/09/2012
Name	Execution Date						
Sung Gun LEE	04/09/2012						
Yong Tak Hyun	04/09/2012						
RECEIVING PARTY DATA							
Name:	Doosan Infracore Co., Ltd.						
Street Address:	7-11, Hwasu-dong, Dong-gu						
City:	Incheon						
State/Country:	REPUBLIC OF KOREA						
Postal Code:	401-020						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13501030</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13501030		
Property Type	Number						
Application Number:	13501030						
CORRESPONDENCE DATA							
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ATTORNEY DOCKET NUMBER:	D297.12-0026/JVK						
NAME OF SUBMITTER:	Theresa R. Sorbel						
Total Attachments: 2 source=2012-04-13assignment#page1.tif source=2012-04-13assignment#page2.tif							

OP \$40.00 13501030

# ASSIGNMENT TO CLARK EQUIPMENT COMPANY

Attorney Docket No.

WHEREAS, we, LEE, Sung Gun of Doosan Corporation 39-3 Seongbok-dong, Suji-gu, Yongin-si, Gyeonggi-do 448-795 Republic of Korea and HYUN, Yong Tak of 104-105 Banpo Jugong Apt., Banpobon-dong, Seocho-gu, Seoul 137-811 Republic of Korea, (hereinafter referred to as ASSIGNORS), are the inventors of an invention entitled TOOL PATH FORMING METHOD IN MILLING PROCESSING SYSTEM for Letters Patent filed pursuant to the Patent Cooperation Treaty and designating of the United States, the international application being identifiable in the Korean Receiving Office by Application No. PCT/KR2010/006906, filed October 8, 2010, and/or the application having been executed on even date herewith, and/or being identifiable in the United States Patent and Trademark Office by Application No. 13/501,030, filed April 9, 2012; and

WHEREAS, Doosan Infracore Co., Ltd., (hereinafter referred to as ASSIGNEE), a limited liability company organized and existing under the laws of Korea, and having offices at 7-11 Hwasu-dong, Dong-gu, Incheon 401-020 Republic of Korea, is desirous of acquiring the entire right, title and interest in and to the invention, the application, and any and all Letters Patent(s) or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, we transfer to Assignee, its successors and assigns, our entire right, title and interest in and to the invention, the above-identified application, corresponding domestic and foreign applications, all Letters Patent or similar legal protection issuing thereon; and all rights and benefits under any applicable treaty or convention; and we authorize the Commissioner of Patents and Trademarks or foreign equivalent thereof to issue the Letters Patent(s) or similar legal protection to the Assignee.

We authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and serial number of the application when ascertained.

We authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent(s) or similar legal protection, in its own name if desired, in any and all foreign countries.

We represent to the Assignee, its successors and assigns, that we have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. We, our executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent(s) or similar legal protection on the invention in any and all countries.

Lee Sung Gun  
Signature of Inventor

Date : 2012. 4. 9

LEE, Sung Gun  
Printed Name of Inventor

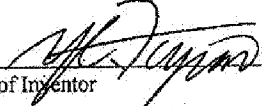
[Signature]  
Signature of Witness

Date : 2012. 4. 9

Shin Young PARK  
Printed Name of Witness

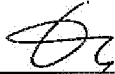
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Signature of Inventor

Date : 2012. 4. 9

HYUN, Yong Tak  
\_\_\_\_\_  
Printed Name of Inventor

  
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Signature of Witness

Date : 2012. 4. 9

Shin Young PARK  
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